



Product Change Notification

Change Notification #: 70550-1

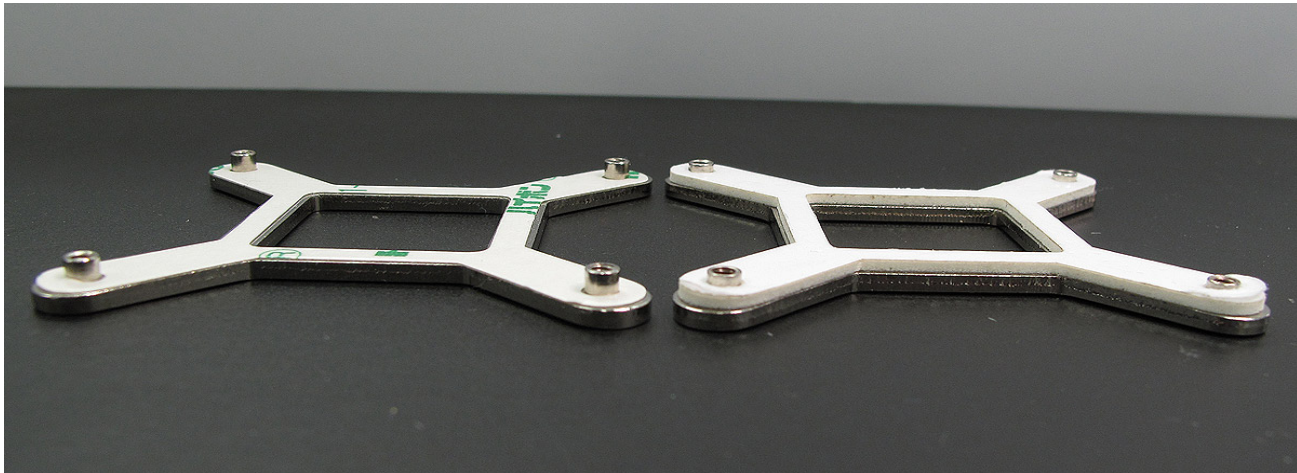
Change Title: BCM® MX965GME Box Package Accessory – CPU Cooler Back Plate Change

Date: 4/6/2009

Key Characteristics of the Change: Accessory

Description of Change:

An additional foam insulator has been added to the CPU cooler back plate. This change will provide greater tolerance and help reduce the potential for a short circuit between the motherboard circuitry and the metal CPU back plate that can occur from improper installation or tightening of the CPU back plate.



Old Back Plate

New Back Plate

Customer Impact of Change and Recommended Action:

BCM anticipates no impact to customers. All MX965GME box products shipped after the PCN issue date will implement this change.

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